

## Description

The PSMTO04R1 uses split gate trench technology to provide excellent  $R_{DS(ON)}$  low gate charge. This device is suitable for power management and high efficiency applications at high switching frequencies applications.

### MOSFET Product Summary

$V_{DS}(V)$	$R_{DS(on)}(m\Omega)$
40	1.8@ $V_{GS} = 10V$

## Feature

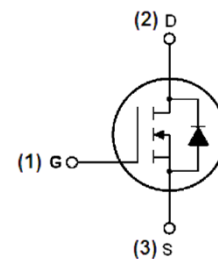
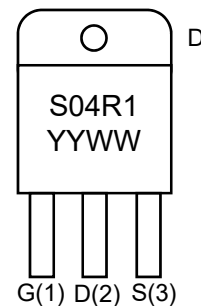
- Low  $R_{DS(ON)}$  - Ensures On-State Losses are Minimized
- Excellent  $Q_{gd} \times R_{DS(ON)}$  Product(FOM)
- Advanced Technology for DC-DC Converts
- Small Form Factor Thermally Efficient Package  
Enables Higher Density End Products
- 100% UIS (Avalanche) Rated
- Lead-Free Finish ; RoHS Compliant
- Halogen and Antimony Free. "Green" Device

## Applications

- PWM applications
- Load switch
- Power management
- DC-DC Converters
- Wireless Chargers

## Absolute maximum rating@25°C

Rating	Symbol	Value	Units
Drain-Source Voltage	$V_{DS}$	40	V
Gate-Source Voltage	$V_{GS}$	±20	V
Drain Current-Continuous <sup>1)</sup>	$I_D$	$T_C=25^\circ C$	224.5
		$T_C=100^\circ C$	142
Pulsed Drain Current <sup>2)</sup>	$I_{DM}$	880	A
Total Power Dissipation <sup>3)</sup>	$P_D$	201.6	W
Avalanche Current <sup>4)</sup>	$I_{AS}$	41.67	A
Avalanche Energy <sup>4)</sup>	$E_{AS}$	86.81	mJ
Thermal Resistance , Junction-case <sup>5)</sup>	$R_{\theta JC}$	3.74	°C/W
Thermal Resistance Junction-to-Ambient <sup>5)</sup>	$R_{\theta JA}$	38.69	°C/W
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55~+150	°C


**TO-220 (Top View)**

**Schematic diagram**

**Marking (Top View)**

## Electrical characteristics per line@25°C (unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	40	-	-	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 40V, V_{GS} = 0V$	-	-	1.0	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	$\pm 100$	nA
<b>On Characteristics</b>						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.0	1.7	2.5	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 6A$	-	1.8	2.4	m $\Omega$
		$V_{GS} = 4.5V, I_D = 6A$	-	2.2	4.0	
<b>Dynamic Characteristics<sup>6)</sup></b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 20V, V_{GS} = 0V,$ $f = 1.0MHz$	-	7954	-	pF
Output Capacitance	$C_{oss}$		-	1379	-	
Reverse Transfer Capacitance	$C_{rss}$		-	45.87	-	
<b>Switching Characteristics<sup>6)</sup></b>						
Turn-on Delay Time	$t_{d(on)}$	$V_{DS} = 20V, V_{GS} = 10V,$ $R_G = 10\Omega, I_D = 6A$	-	28.1	-	ns
Turn-on Rise Time	$t_r$		-	31.6	-	
Turn-Off Delay Time	$t_{d(off)}$		-	161.1	-	
Turn-Off Fall Time	$t_f$		-	42.5	-	
Total Gate Charge	$Q_g$	$V_{DS} = 20V, V_{GS} = 10V,$ $I_D = 6A$	-	83.1	-	nC
Gate-Source Charge	$Q_{gs}$		-	22.5	-	
Gate-Drain Charge	$Q_{gd}$		-	6.7	-	
Gate Resistance	$R_g$	$V_{GS}=0V, V_{DS}=0V, f=1MHz$	-	1.0	-	$\Omega$
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage	$V_{SD}$	$V_{GS} = 0V, I_S = 50A$	-	-	1.3	V

## Notes:

1. Computed continuous current assumes the condition of  $T_{J\_Max}$  while the actual continuous current depends on the thermal & electro-mechanical application board design.
2. Repetitive Rating: Pulse width limited by maximum junction temperature( $T_{J\_Max}=150^\circ C$ ).
3. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .
4. This single-pulse measurement was taken under the following condition ( $L=100\mu H, V_{GS}=10V, V_{DS}=50V$ )while it's value is limited by  $T_{J\_Max}=150^\circ C$ .
5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout.
6. Guaranteed by design, not subject to production.

Typical Characteristics

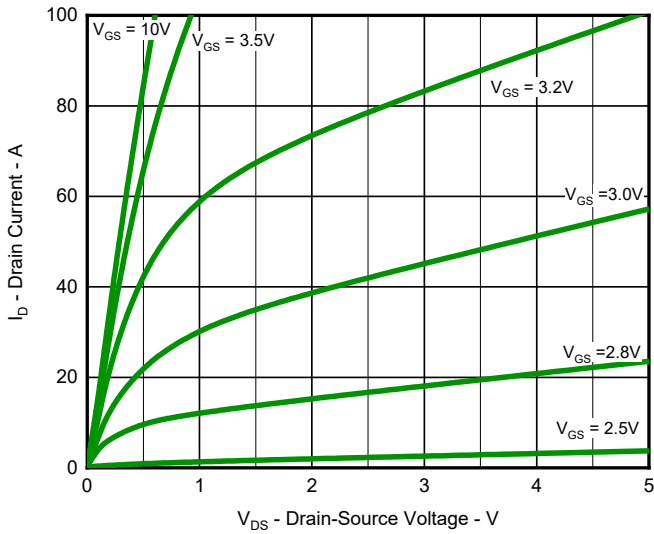


Fig.1 Output Characteristics

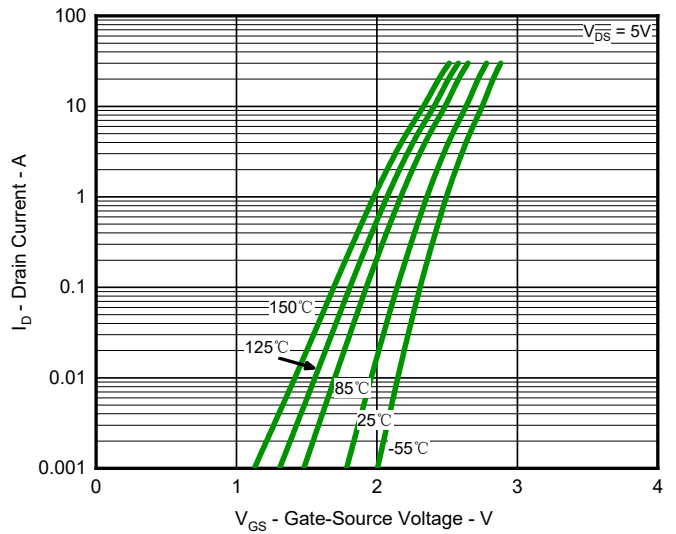


Fig.2 Typical Transfer Characteristic

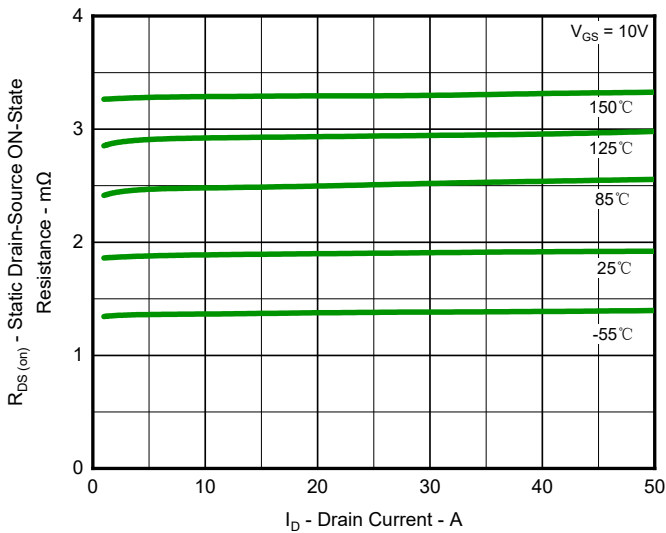


Fig.3 Typical On-Resistance vs Drain Current and Temperature

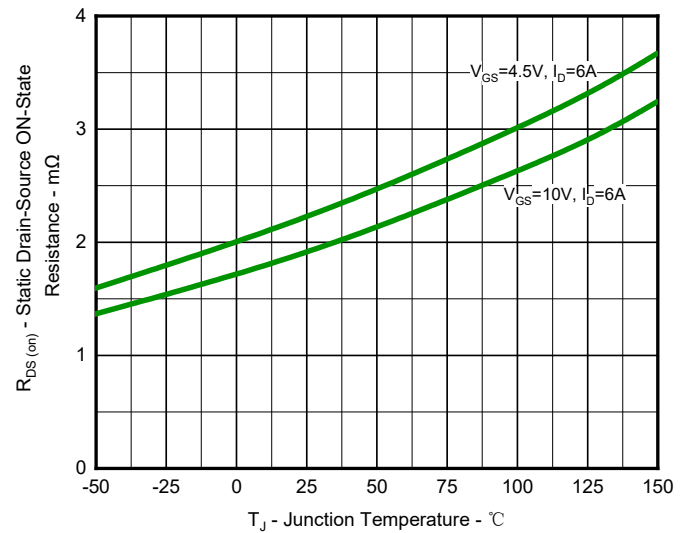


Fig.4 On-Resistance Variation with Temperature

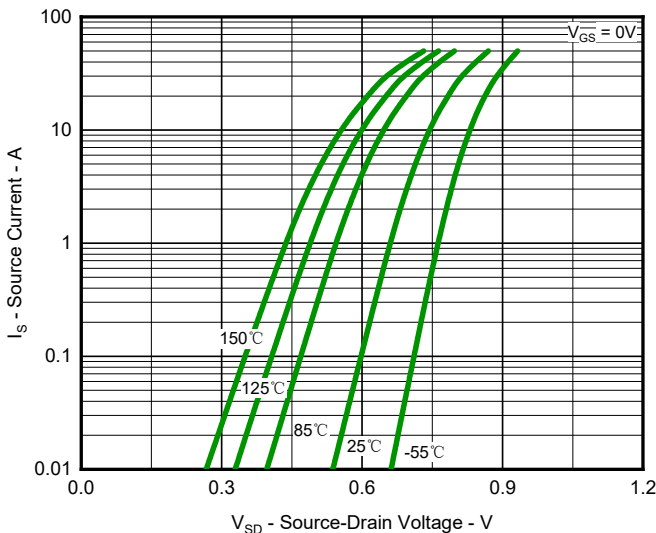


Fig.5 Diode Forward Voltage vs. Current

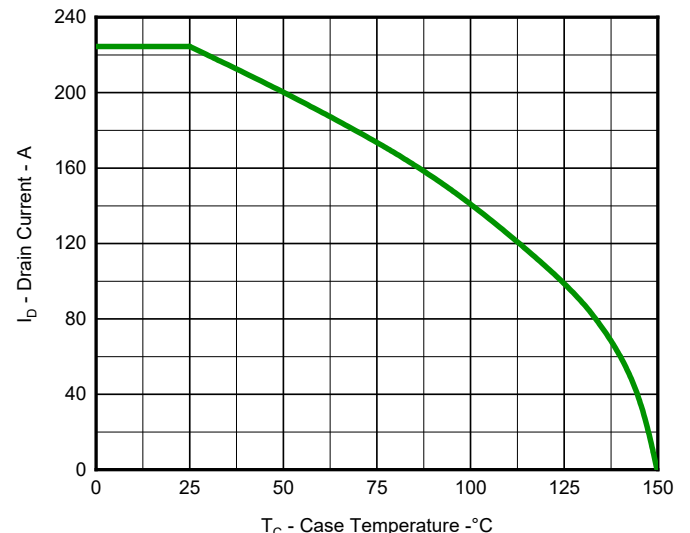


Fig.6 Maximum Drain Current vs. Case Temperature

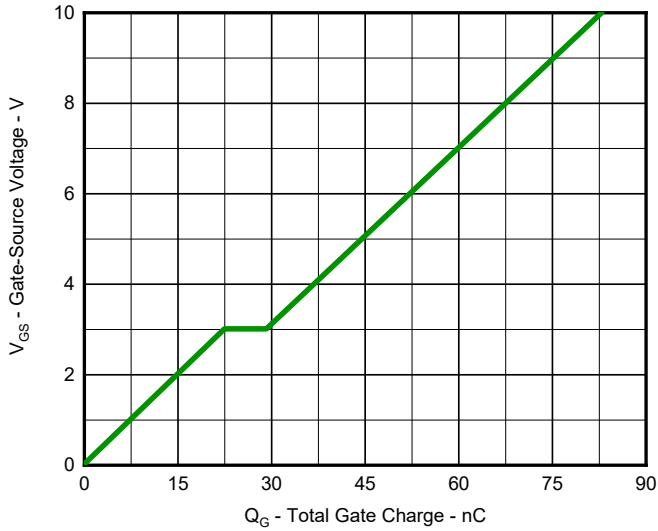


Fig.7 Gate Charge Characteristics

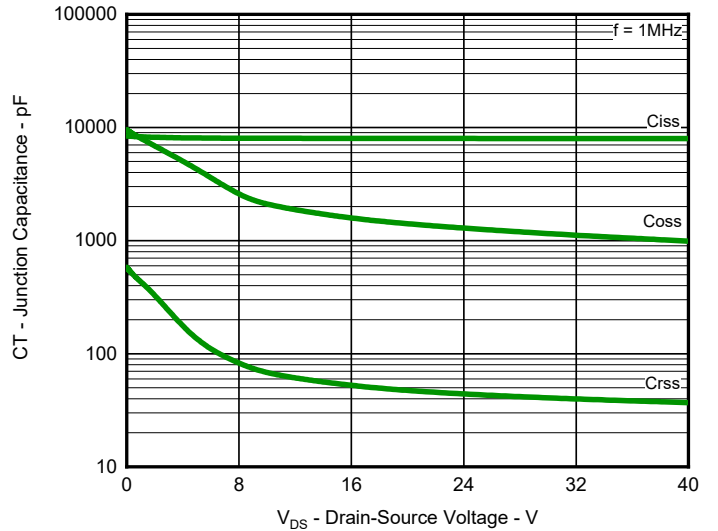


Fig.8 Typical Junction Capacitance

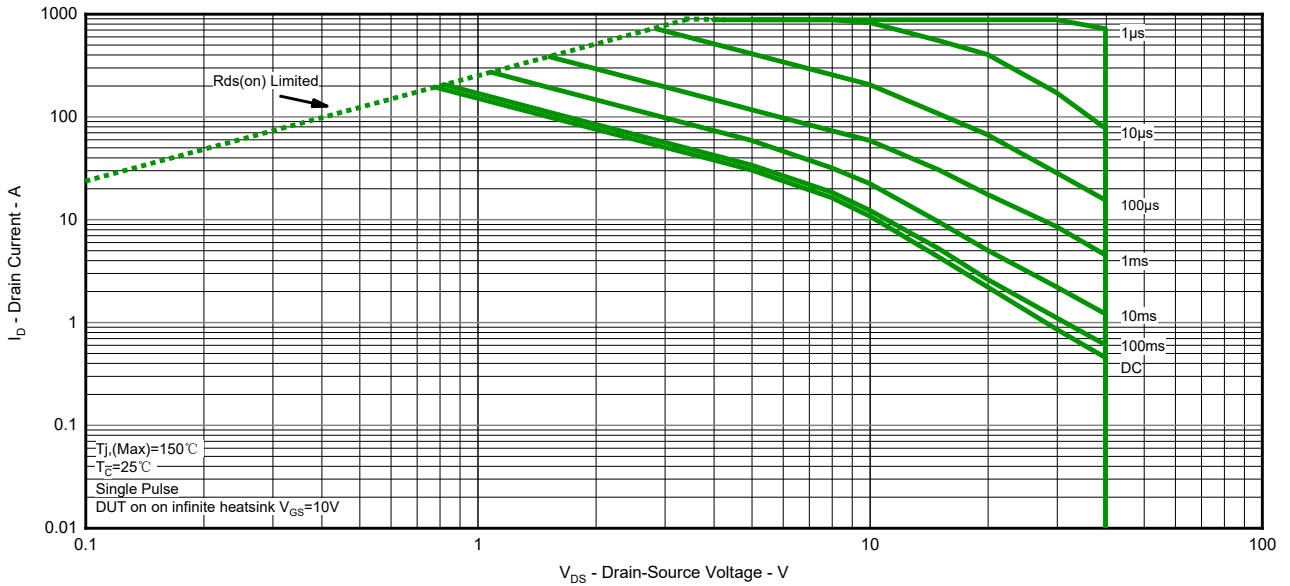


Fig.9 Safe Operation Area

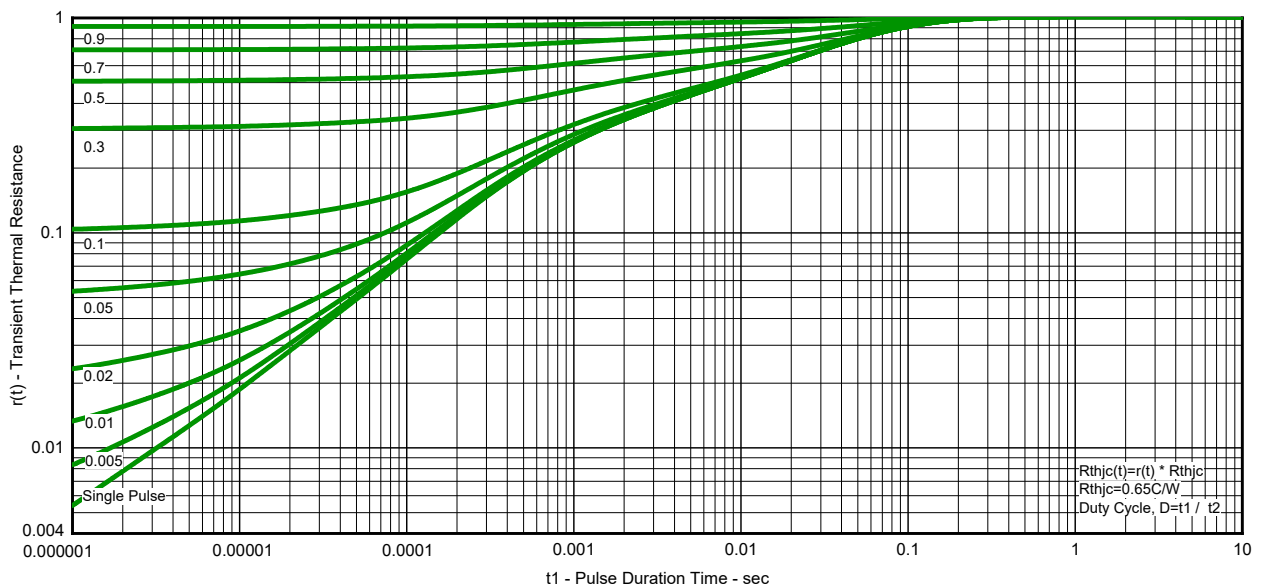
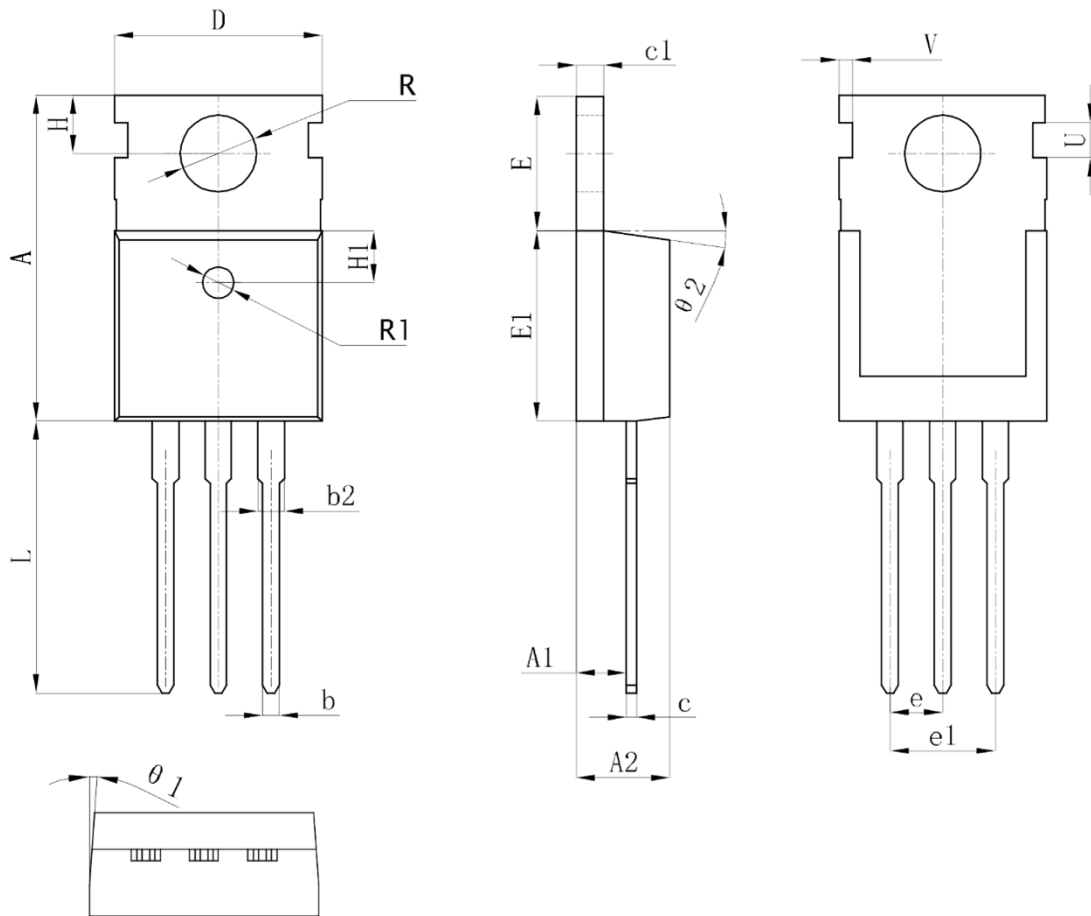



Fig.10 Transient Thermal Resistance

## Product dimension (TO-220)



Dim	Millimeters		Inches		Dim	Millimeters		Inches	
	Min	Max	Min	Max		Min	Max	Min	Max
A	15.40	15.80	0.606	0.622	e1	4.84	5.32	0.191	0.209
A1	2.35	2.50	0.093	0.098	H	2.73	2.87	0.107	0.113
A2	4.40	4.70	0.173	0.185	H1	2.40	2.60	0.094	0.102
b	0.70	0.90	0.028	0.035	L	13.02	13.72	0.513	0.540
b2	1.18	1.44	0.046	0.057	R	3.50	3.63	0.138	0.143
c	0.48	0.56	0.019	0.022	R1	1.40	1.60	0.055	0.063
c1	1.29	1.32	0.051	0.052	U	1.65	1.85	0.065	0.073
D	9.80	10.20	0.386	0.402	V	0.58	0.78	0.023	0.031
E	6.40	6.60	0.252	0.260	$\theta_1$	2°	3°	2°	3°
E1	9.00	9.20	0.354	0.362	$\theta_2$	6.5°	7.5°	6.5°	7.5°
e	2.42	2.66	0.095	0.105					


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版本	修改说明			申请/修改者	生效日期
6.0	新增, 只填写静态数据, C25尺寸			Bert/Tim	2023-01-05
	根据实测数据, 补全参数和曲线图			Bert/Tim	2023-01-16
审核	Maksim	日期	2023-01-05	核准	Ken
		日期			2023-01-05